



广州市东裕光电科技有限公司

# 产品规格书

## SPECIFICATION

客户名称 CUSTOMER	
产品名称 PRODUCTION	红外线接收头 Infrared Receiver Module
产品型号 MODEL	DY-IRM383/LP-T-20
版本号 VERSION NO	A1.0

厂址(Add): 广东省广州市番禺区石基镇海涌路3号10号厂房2楼

电话(Tel): 020-39294688

传真(Fax): 020-39966833

邮箱(E-mail): zlx@dyled.cn

网址(Net): www.tonyuled.com



客户确认 CUSTOMER CONFIRMATION	审核 CHECKED BY	编制 PREPARED BY
		区家俊

## 产品描述 Descriptions

- DY-IRM383/LP-T-20 内含高速高灵敏度 PIN 光电二极管和高增益前置放大 IC，采用环氧树脂塑封封装设计，在红外遥控系统中作为接收器使用。

## 产品特性 Features

- 小体积环氧塑封封装；
- 工作电压：2.7-5.5V；
- 抗干扰能力强，能抵挡环境干扰；
- 灵敏度高，低功耗及长距离接收；
- 符合 RoHS 要求。

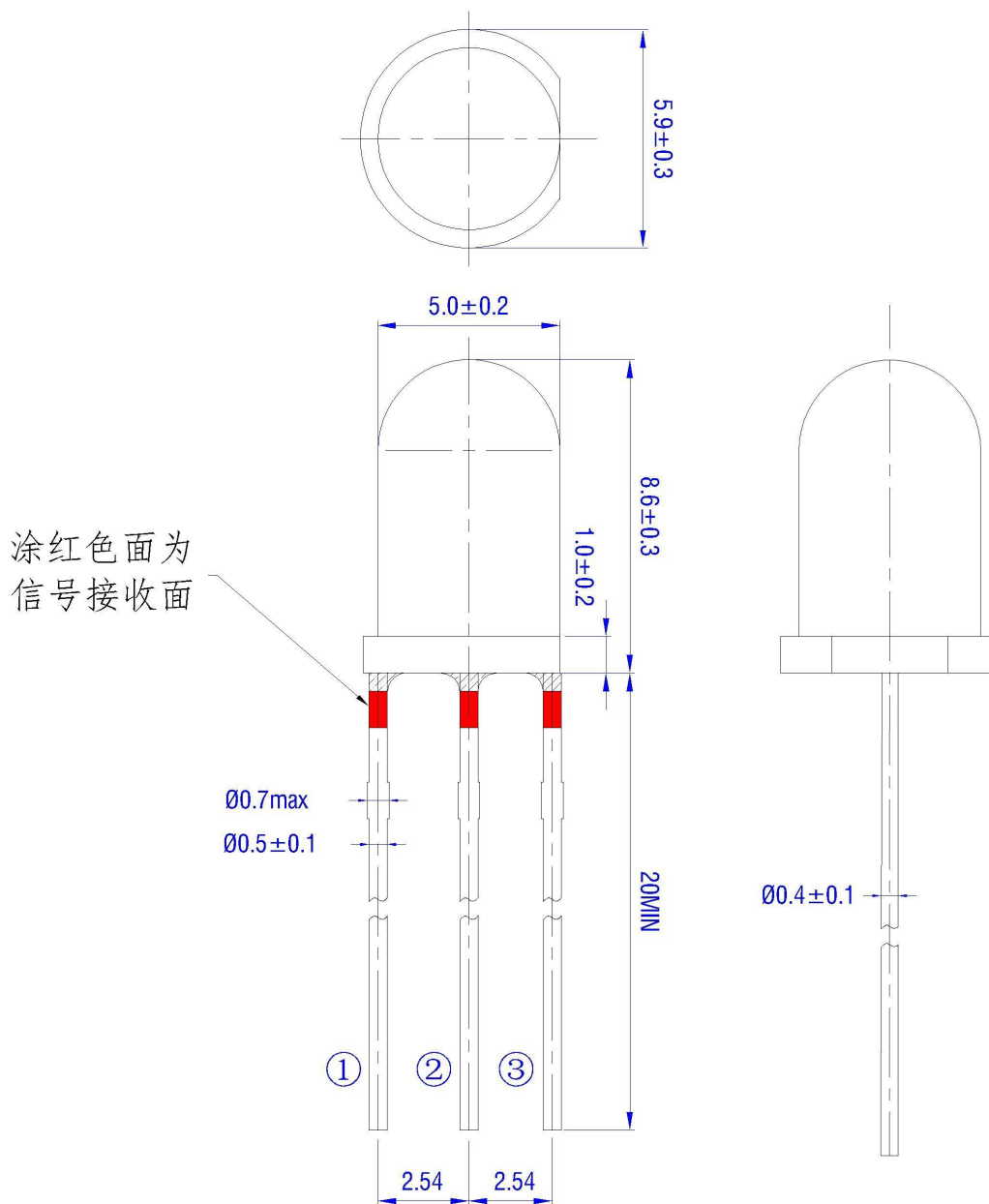
## 产品应用 Applications

- 视听器材(车载 MP3、MP4,硬盘播放器等)
- 游戏（遥控飞机、汽车，车载游戏机等）
- 其它红外线遥控产品

## 包装方式 Packing Quantity Specification

- 500PCS/袋(500PCS/1bag)

## 一、外形图 Outline Dimensions:

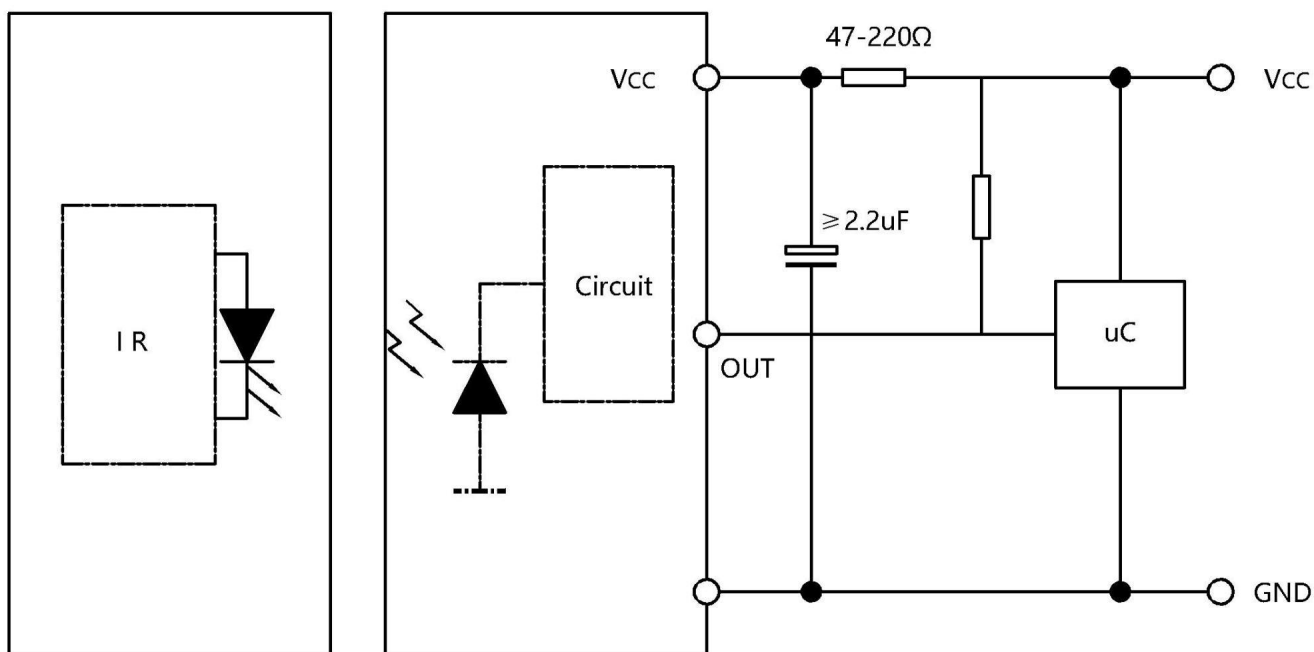


Pin configuration

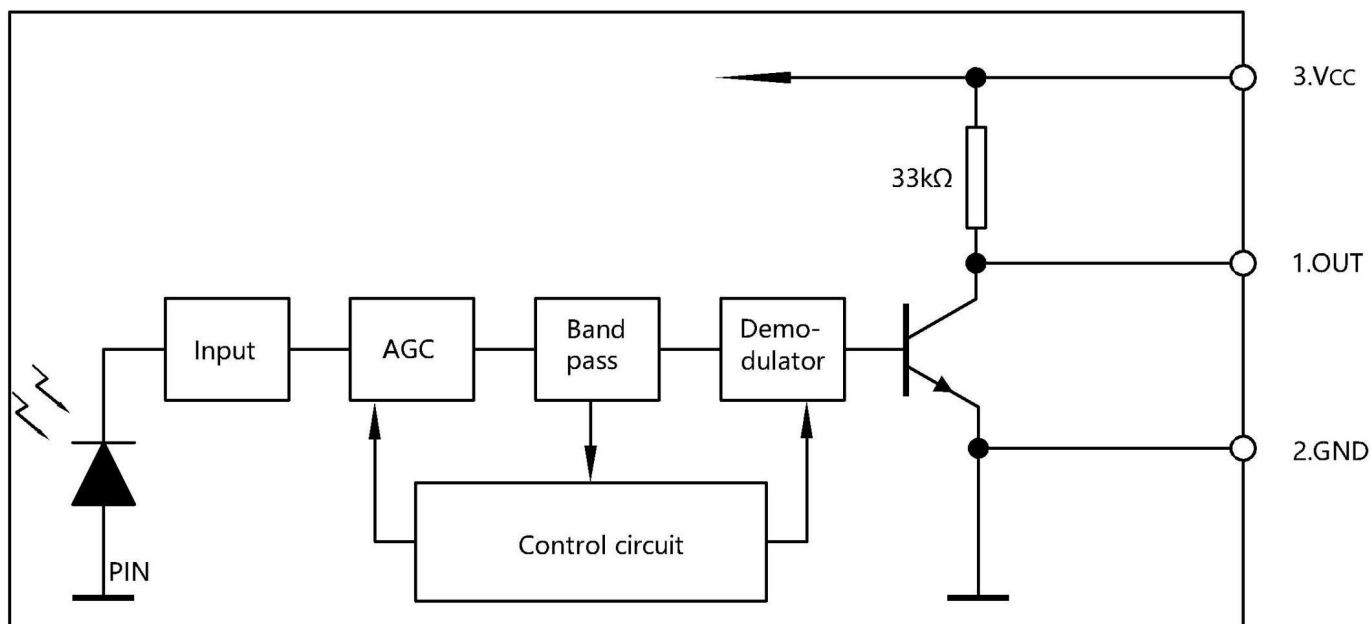
- 1、OUT
- 2、GND
- 3、VCC

Notes: Tolerance is  $\pm 0.2$  unless otherwise noted

## 二、应用电路 Application Circuit

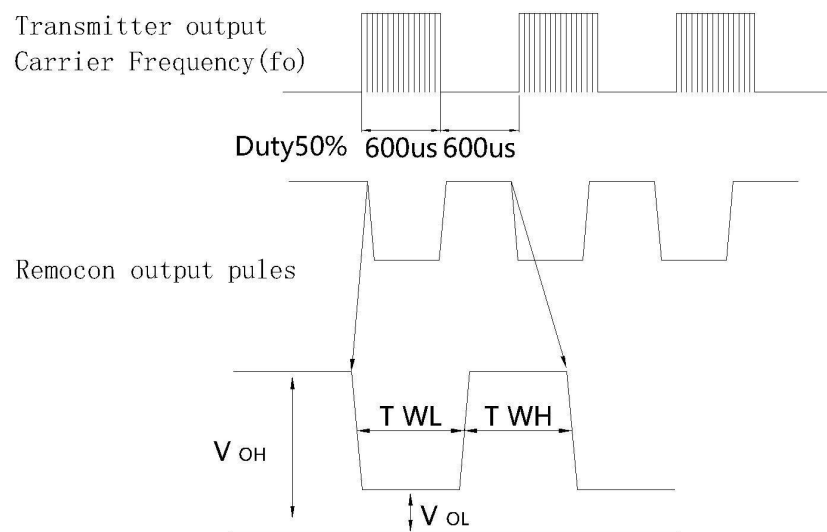


## 三、原理图 Block Diagram

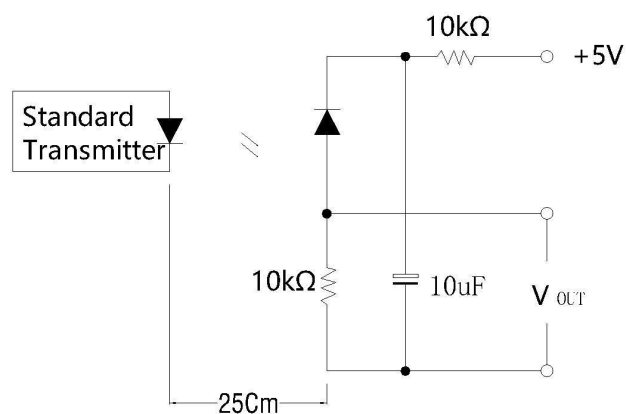


## 四、测试方式 Measure Method

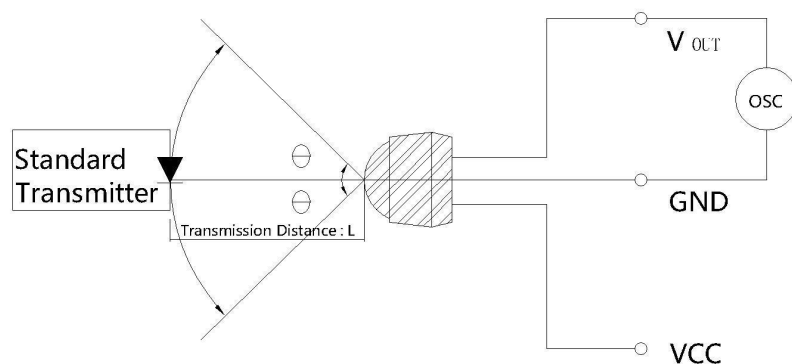
### 1、Output Pulse Width



### 2、Standard Transmitter



### 3、Test Condition of Transmission Distance



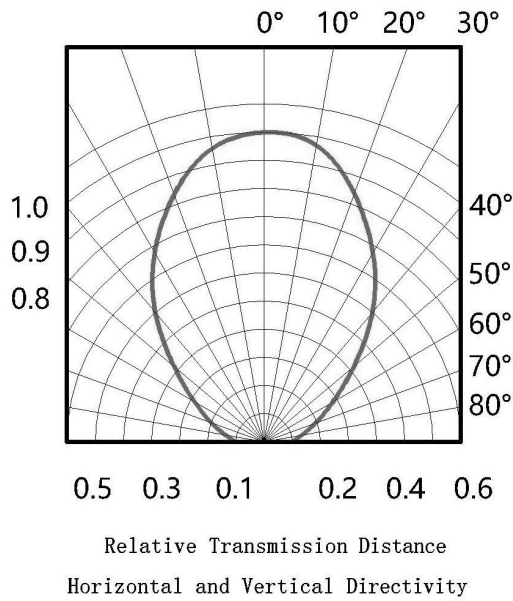
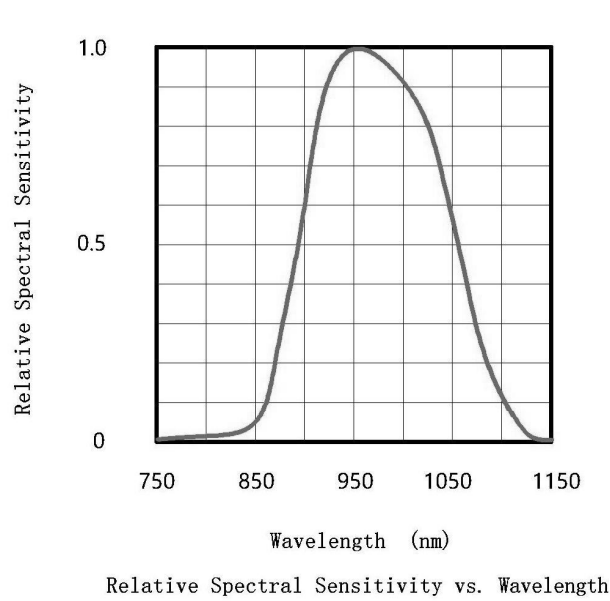
⊖ : Indicates horizontal and vertical directions

五、光电参数 Electro-Optical Characteristics

(环境温度 Ambient temperature: 25°C, 环境湿度 Humidity: RH60%)

参数	符号	测试条件	Min	Type	Max	单位
工作电流	Icc	Ev=0, Vs=3.3V	0.1	0.22	0.29	mA
工作电压	Vcc		2.7	-	5.5	V
接收距离	L0	IR diode 333C-A IF=50mA 30pulses, f=f0, t=10ms	-	16	-	M
	L45		7.5	-	-	
载波频率	F0	37.9				KHZ
峰值波长	$\lambda_p$		-	940	-	nm
低电平输出	VoL		-	0.2	0.4	V
高电平输出	VoH		2.7	-	-	V
最小脉冲宽度	TwL		450	-	750	us
最大脉冲宽度	TwH		450	-	750	us
半功率角	Tburst gap	Angle of half transmission distance	-	$\pm 45$	-	us

六、典型参数 Tyical Characteristics



## 六、极限参数 Absolute Maximum Ratings

项目	符号	规格	单位
供应电压	Vcc	6.0	V
供应电流	Icc	3	mA
输出电压	Vout	-0.3 to (Vcc+0.3)	V
储存温度	Tstg	-25~80	°C
工作温度	Topr	-25~80	°C
功耗*1	Ptot	10	mW
焊接温度*2	Tsol	260	°C

\*1 环境温度≤80°C

\*2 指产品处于非受力状态下的焊接温度，焊接距离距产品胶体与引脚根部 2.0mm 以上，焊接时间不超过 5s

## 七、注意事项 Note:

### 1、引脚成形方法 LED bracket forming method

(1) 必需离胶体 2 毫米才能折弯支架。

The pin of LED can be bent where is at least 2mm out of LED colloid.

(2) 支架成形必须用夹具或由专业人员来完成。

Must use fixture to deform the LED bracket.

(3) 支架成形必须在焊接前完成。

Finishing the forming of LED bracket must be before soldering.

(4) 支架成形需保证引脚和间距与线路板上一致。

Guarantee the gap between two pin of LED tallys with LED pads in PCB when forming.

### 2、焊接条件 Soldering condition

(1) 烙铁：烙铁（最高 30W）尖端温度不超过 300°C；焊接时间不超过 3 秒；焊接位置至少离胶体 3 毫米。

Soldering iron:The tip temperature of soldering iron don't exceed 300°C；soldering time don't exceed 3s and soldering position must be 3mm out of led colloid。

(2) 波峰焊：请在 260°C且 5 秒以内一次焊接完成,同时应避免树脂胶体浸入锡槽内,焊点需离引脚与树脂胶体根部 2mm 以上。

Wave-soldering:Complete the welding in 260°C and within 5 seconds at one time, and avoid the resin colloid immersion into the tin tank, the solder joint should be more than 2mm from the pin and the root of the resin colloid.

(3) 回流焊：回流焊建议温度 220-250°C，一次焊接完成。

reflow soldering: The recommended temperature of reflow soldering is 250-260°C，complete soldering at one time.

### 3、防静电措施 ESD countermeasure

静电及高压会对 LED 造成损坏，特别是芯片材质为 InGaN 的产品对静电防护要求更加严格，要求在使用和检验产品时戴防静电手腕带或防静电手套，焊接工具及设备外壳需可靠接地，焊接条件遵循此份规格书中的条件。

Static electricity and high volt can damage LED, The production whose Die material is InGaN must strictly required to prevent ESD, Must put on static glove and static fillet, Soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.

### 4、过电流保护 Protecting countermeasure when over current

为避免由于电压的变化引起大电流冲击而造成产品损坏，需要加入保护电阻。

Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation.

### 5、LED 安装方法 LED installation method

- (1) 注意各类器件外线的排列以防极性装错，器件不可与发热组件靠得太近，工作条件不要超过其规定的极限。

Pay attention to the LED polarity and avoid installation wrong. LED can't be close to euthermic component, work condition should tally with it's specification.

- (2) 务必不要在引脚间距变形的情况下安装 LED。

Don't install the LED under the condition of the led pin deformation.

- (3) 当装配 LED 进入 PCB 或装配孔时，LED 支架不能承受任何压力。

The LED bracket don't load any pressure when installing the LED into PCB or fitting hole.

- (4) 在焊接温度回到正常以前，必须避免使 LED 受到任何的震动或外力。

Must avoid any strike and force on LED before the soldering temperature return to room temperature.

### 6、存储时间 Storage time

- (1) 在温度 5°C~35°C，湿度 RH60%条件下，产品可保存一年。超过保存期的产品需重新检测后方能使用。

LED can be stored for a year under the condition: the temperature of 5°C~35°C and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

- (2) 如果打开的产品在 5°C~35°C，RH60%的空气条件下放置超过一周，则需要将产品在 65°C±5°C的环境中放置 24 小时以上，并尽量在十五天内使用。

If LED is exposed in air for a week under the condition: the temperature of 5°C~35°C, humidity of RH60%, must place the LED in the ambience of 65°C±5°C for 24 hours and use it in 15 days for best.

### 7、清洗 Cleaning

当用化学用品清洗胶体时必须特别小心，因为有些化学品对胶体表面有损伤并引起褪色如三氯乙烯、丙酮等。可用乙醇擦拭、浸渍，时间在常温下不超过 3 分钟。

Be careful of some chemical results in the LED colloid fades and damage when using chemical clean the LED, such as chloroethylene, acetone etc. Can use ethanol to wash or soak LED but the time don't exceed 3 minutes.



#### 8、弯脚 Kinked

当 LED 成形弯脚时，弯脚模具容易刮花 LED 脚支架镀层，刮伤处容易生锈，特别是空气湿度大时。为减少生锈机会，建议使用镀锡支架。

The kinked tooling scrape easily the pin of LED, where the LED bracket is rusting easily, especial expose it in moist air. To decrease the LED bracket rust, advise using plated tin LED bracket.